DATA SHEET



PHOTOCOUPLER PS2765-1

HIGH ISOLATION VOLTAGE AC INPUT RESPONSE TYPE 4-PIN SOP PHOTOCOUPLER

-NEPOC[™] Series-

DESCRIPTION

The PS2765-1 is an optically coupled isolator containing GaAs light emitting diodes and an NPN silicon phototransistor.

This package is mounted in a plastic SOP (Small Outline Package) for high density applications. The package has shield effect to cut off ambient light.

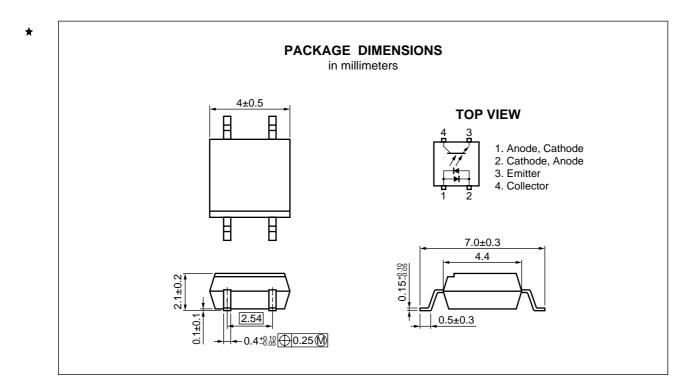
★ FEATURES

- Isolation distance (0.4 mm MIN.)
- AC input response
- SOP (Small Outline Package) type
- High isolation voltage (BV = 3 750 Vr.m.s.)
- High-speed switching (tr = 4 μ s TYP., tr = 5 μ s TYP.)
- Ordering number of taping product: PS2765-1-F3, F4
- UL approved: File No. E72422 (S)
- BSI approved: No. 8436/8437

APPLICATIONS

- Hybrid IC
- Programmable logic controllers
- Power supply

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PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)			
Air Distance	5 mm			
Creepage Distance	5 mm			
Isolation Distance	0.4 mm			

★ ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number ^{*1}
PS2765-1	4-pin SOP	Magazine case 100 pcs	PS2765-1
PS2765-1-F3		Embossed Tape 3 500 pcs/reel	
PS2765-1-F4			

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	lF	± 50	mA	
	Power Dissipation	P⊳	80	mW	
	Peak Forward Current ¹	I FP	± 1.0	А	
Transistor	Collector to Emitter Voltage	Vceo	40	V	
	Emitter to Collector Voltage	Veco	5	V	
	Collector Current	lc	40	mA	
	Power Dissipation Derating	⊿Pc/°C	1.5	mW/°C	
	Power Dissipation	Pc	150	mW	
Isolation Voltage ^{*2}		BV	3 750	Vr.m.s.	
Operating Ambient Temperature		TA	-40 to +100	°C	
Storage Temperature		Tstg	–55 to +150	°C	

★ ★

*1 PW = 100 μ s, Duty Cycle = 1 %

*2 AC voltage for 1 minute at $T_A = 25$ °C, RH = 60 % between input and output

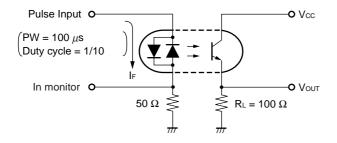
★ ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	$I_F = \pm 5 \text{ mA}$		1.1	1.4	V
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		30		pF
Transistor	Collector to Emitter Dark Current	Iceo	IF = 0 mA, VCE = 40 V			100	nA
Coupled	Current Transfer Ratio (Ic/IF) ^{*1}	CTR	IF = ± 5 mA, VCE = 5 V	50	100	400	%
	Collector Saturation Voltage	Vce (sat)	$I_F = \pm 10 \text{ mA}, \text{ Ic} = 2 \text{ mA}$			0.3	V
	Isolation Resistance	R⊦o	VI-O = 1 kVDC	10 ¹¹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		0.4		pF
	Rise Time ^{⁺2}	tr	$Vcc = 5 V, Ic = 2 mA, RL = 100 \Omega$		4		μs
	Fall Time ^{'2}	tr			5		

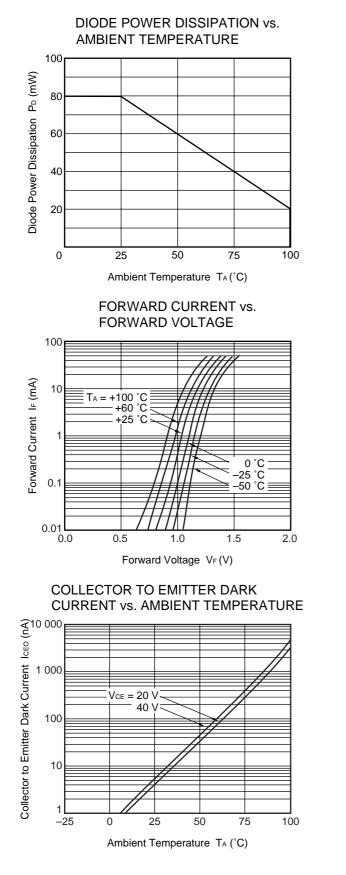
★ *1 CTR rank

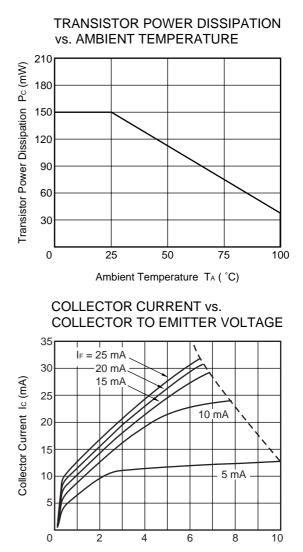
N: 50 to 400 (%)

*2 Test circuit for switching time



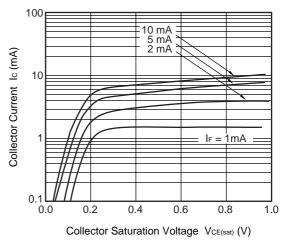
★ TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

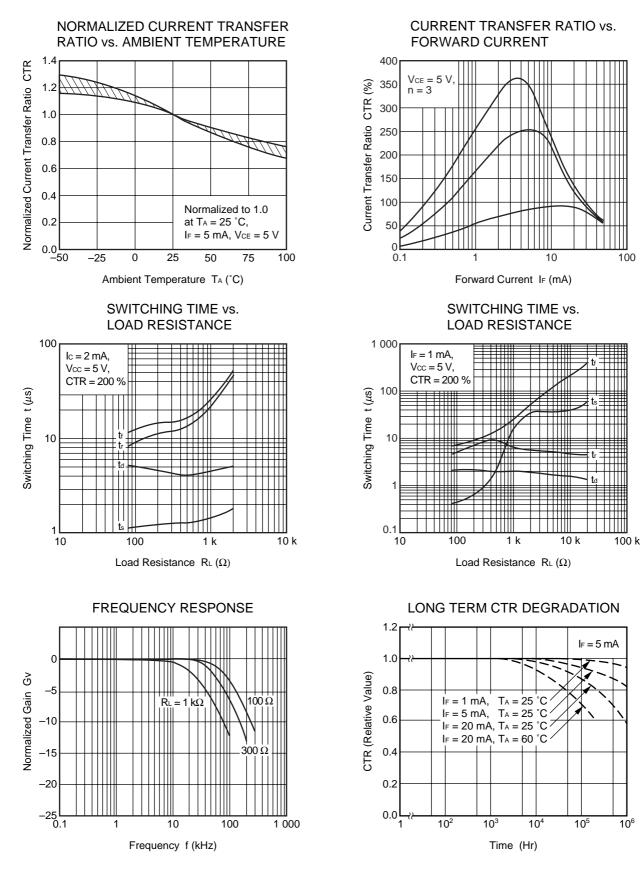




Collector to Emitter Voltage VCE (V)

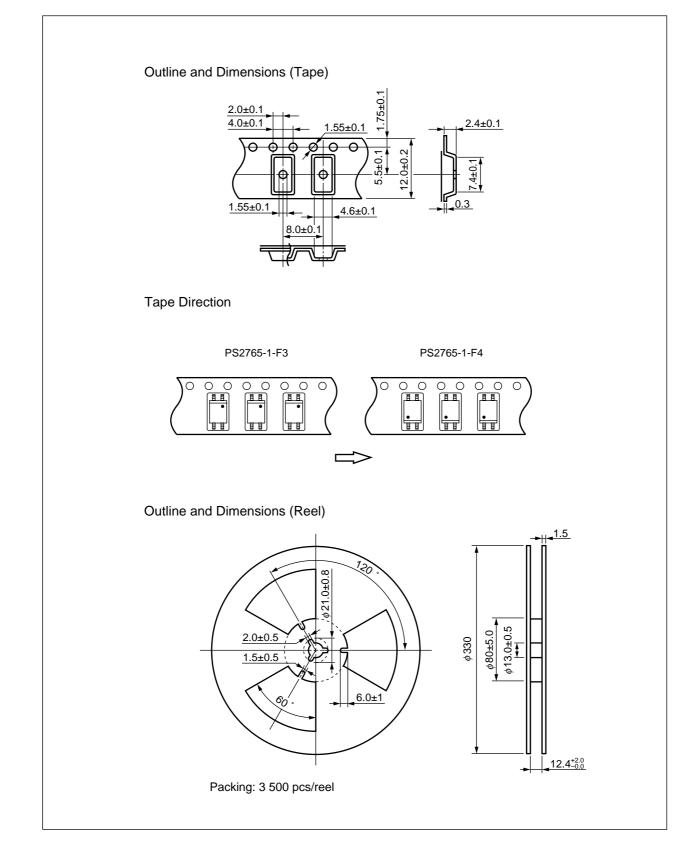
COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE





Remark The graphs indicate nominal characteristics.

★ TAPING SPECIFICATIONS (in millimeters)



★ NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

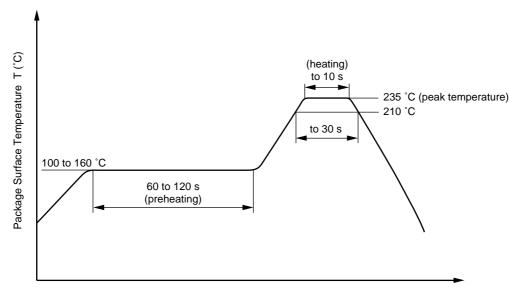
- Peak reflow temperature
- Time of temperature higher than 210 °C
- Number of reflows
- Flux

235 °C or below (package surface temperature) 30 seconds or less

Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

Recommended Temperature Profile of Infrared Reflow





(2) Dip soldering

• Temperature 260 °C or below (molten solder temperature)

- Time 10 seconds or less
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
 - Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(3) Cautions

• Flux

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between corrector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

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CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

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